

Loctite® CHIPBONDER® 3615 High Adhesion, Syringe Dispense

Category : Polymer , Adhesive , Thermoset

Material Notes:

Surface Mount Adhesives Loctite® Chipbonder® Surface Mount Adhesives (SMAs) maintain component positioning during wave solder and solder reflow processes. Loctite offers a variety of application techniques including syringe dispense, stencil print and pin transfer. Loctite® syringe dispense products provide good performance for electronics assembly: High Speed Dispense Low Temperature Cure Products for difficult-to-bond substrates Loctite® 3615 CHIPBONDER® High Adhesion, Syringe Dispense Formulated specifically for hard to bond components. Low moisture pick up. Ideal for Archimedes and piston pump dispense systems. Peaked dot profile. Process Method: Medium speed Syringe dispensing 18,000 DPH capable Storage (Protect from heat): 40°F (+/-5°F) or 5°C (+/-3°C)

Order this product through the following link:

http://www.lookpolymers.com/polymer_Loctite-CHIPBONDER-3615-High-Adhesion-Syringe-Dispense.php

Processing Properties	Metric	English	Comments
Cure Time	1.00 - 1.50 min	0.0167 - 0.0250 hour	
	@Temperature 150 °C	@Temperature 302 °F	
Shelf Life	6.00 Month	6.00 Month	From date of manufacture

Descriptive Properties	Value	Comments
Color	Red	

Contact Songhan Plastic Technology Co.,Ltd.

Website : www.lookpolymers.com

Email : sales@lookpolymers.com

Tel : +86 021-51131842

Mobile : +86 13061808058

Skype : lookpolymers

Address : United North Road 215, Fengxian District, Shanghai City, China